

### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic		Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	1,000	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	700	V
Average Rectified Output Current (Note 5)@ $T_A = +40$ °C (Note 6)@ $T_A = +40$ °C	lo	0.5 0.8	А
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	30	А
I <sup>2</sup> t Rating for Fusing (1ms < t < 8.3ms)	l <sup>2</sup> t	3.74	A <sup>2</sup> S

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 6) (Per Element)	$R_{\theta JA}$	101	°C/W
Typical Thermal Resistance, Junction to Lead (Per Element)	R <sub>θJL</sub>	42	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

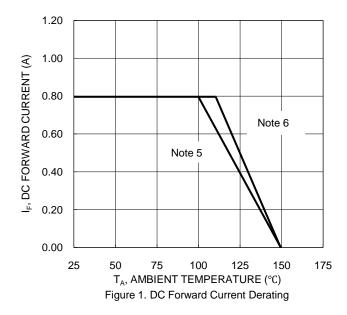
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

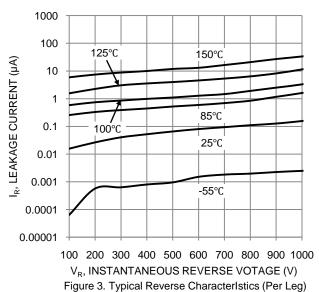
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	1,000	_	_	V	$I_R = 5\mu A$
Forward Voltage (Per Element)	$V_{F}$	_	0.93	1.1	V	$I_F = 0.8A, T_A = +25^{\circ}C$
Leakage Current (Note 7) (Per Element)	I <sub>R</sub>		0.2 21	5 500	μΑ	V <sub>R</sub> = 1,000V, T <sub>A</sub> = +25°C V <sub>R</sub> = 1,000V, T <sub>A</sub> = +125°C
Total Capacitance (Per Element)	Ст	_	8	_	pF	$V_R = 4V$ , $f = 1.0MHz$

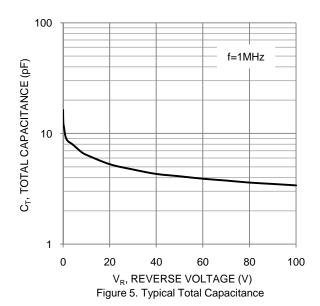
Notes:

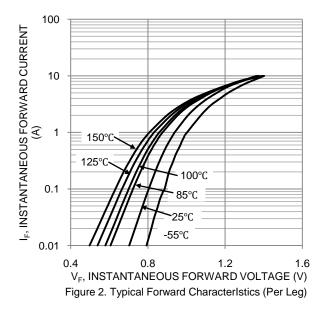
- 5. Device mounted on FR-4 substrate, 1"\*1", 2oz, single-sided, PC boards with 0.1"\*0.15" copper pad. 6. Device mounted on FR-4 substrate, 0.4"\*0.5", 2oz, single-sided, PC boards with 0.2"\*0.25" copper pad.
- 7. Short duration pulse test used to minimize self-heating effect.











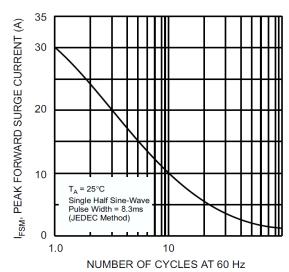


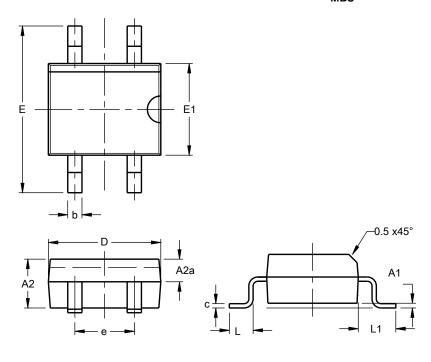
Figure 4. Maximum Peak Forward Surge Current (Per Leg)



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### MBS

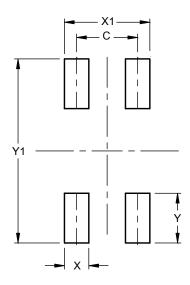


MBS				
Dim	Min	Max	Тур	
A1		0.20		
A2	2.30	2.70		
A2a	0.90	1.30		
b	0.50	0.70		
С	0.15	0.25		
D	4.50	4.95		
Е		7.00		
E1	3.60	4.10		
е	2.30	2.70		
L	0.60	1.10		
L1		1.70		
All Dimensions in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **MBS**



Dimensions	Value (in mm)
С	2.50
Х	1.00
X1	3.50
Υ	2.15
Y1	7.50



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